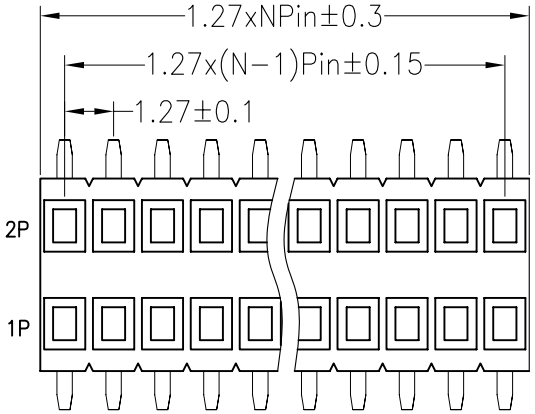
HSF RoHS

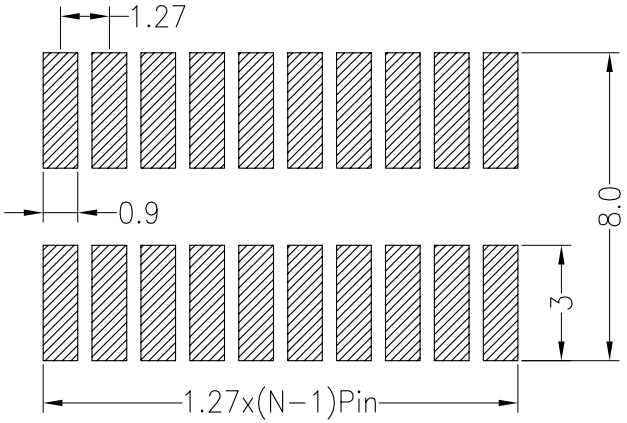
FILE NO :E362810

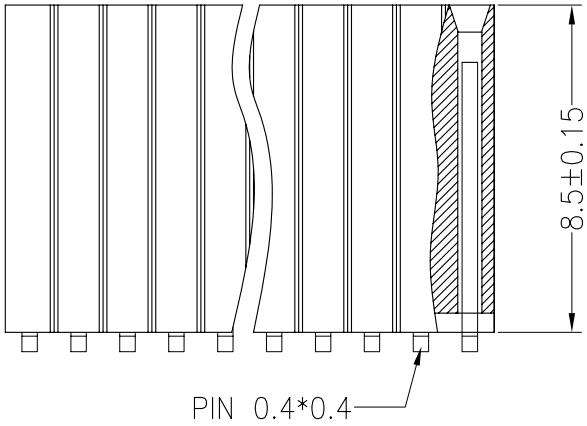
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

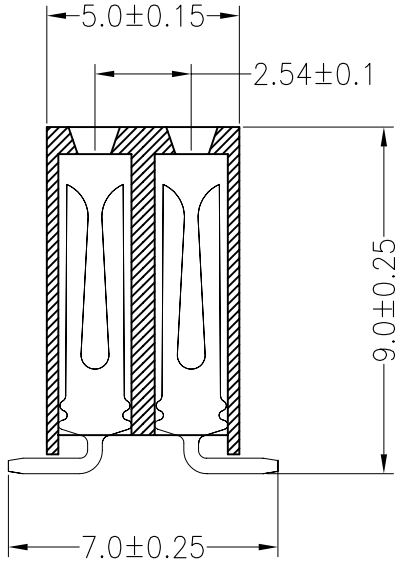
Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

2585 02 XX X N XX M Y X 01

- XX — No.of Pins Per Row 2*50
- X — Insulator Material Option
  A=BK−PBT
  B=BK−PA66
  C=BK−PA6T
  D=BK−PA46
  F=BK−LCP
- XX — Contact Plating
  G0:Gold Flash
  G2:5U" Gold
  G3:10U" Gold
  G4:15U" Gold
  G5:30U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X — Packing
  0=PE Bag
  T=Tube
  P=Tube+Cap
  R=Reel+Cap
  M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2015.01.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	15.01.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	258502XXXNXXMYX01
TITLE:	1.27x2.54PF 2xNPin H8.5 SMT